

# UltraFast Design Methodology Quick Reference Guide (UG1231)

## INTRODUCTION

The UltraFast Design Methodology is a set of best practices recommended to maximize productivity and reduce design iterations of complex systems, including embedded processor subsystems, analog and digital processing, high-speed connectivity, and network processing. See the *UltraFast Design Methodology Guide for FPGAs and SoCs* (UG949) for more information.

The *UltraFast Design Methodology Checklist* (XTP301) includes common questions that highlight typical areas where design decisions have downstream consequences and draws attention to potential problems that are often unknown or ignored. It provides easy access to related collateral. The checklist is available within the AMD Documentation Navigator tool (DocNav).

This quick reference guide highlights key design methodology steps to achieve quicker system integration and design implementation and to derive the greatest value from AMD devices and tools for the following design tasks:

- Board and Device Planning
- Design Entry and Implementation
- Top-Level Design Validation
- Design Analysis
- Design Closure

See the UltraFast Design Methodology – System-Level Design Flow available in the AMD Documentation Navigator tool (DocNav) for pointers to Design Hubs and collateral.

**Note:** The AMD UltraFast™ design methodology applies to the AMD UltraScale™, AMD UltraScale+™, and 7 series device families only. For newer devices, see the *Versal Adaptive SoC Design Guide* (UG1273).



## BOARD AND DEVICE PLANNING

### PCB Designer

#### Examine Key Interfaces

- Validate part orientation and key interfaces

#### Examine the PCB Layout

- Perform the Memory Interface and Transceiver Checklists
- Follow PCB layout recommendations, including thermal solution, placement, and mounting
- Ensure final FPGA pinout is signed off by designer

#### Review the Schematic

- Complete PCB Checklist review
- Validate PDS, decoupling capacitors, and configuration connectivity
- Validate I/O state before, during, and after configuration

#### Manufacture and Test

- Verify the configuration sequence, power supplies, and I/O performance with the test I/O project

#### See Also:

[UG949: Board and Device Planning PCB Design Checklist](#)  
[Memory Interface IP Design Checklists](#)  
[Schematic Design Checklists \(7 series, AMD UltraScale™, and AMD UltraScale+™ devices\)](#)

### FPGA/SoC Designer

#### Analyze Device for Pinout

- Examine transceiver and bonded I/O locations
- Examine SSI technology I/O planning
- Validate part orientation and key interfaces

#### Define I/O Pinouts for Key Interfaces

- Create I/O planning projects
- Define and validate memory controllers, GTs, and PCIe® technology locations
- Establish a clocking skeleton
- Minimize floorplan distance between connected IP

#### Define Final Pinout

- Merge interface projects into a final I/O project
- Validate DRCs and SSN
- Implement design to check clocking and I/O rules
- Use the final I/O project for production test

#### Estimate Power

- Determine power budget using XPE and perform thermal simulation using DELPHI models
- Apply toggle rates using knowledge of prior designs

#### See Also:

[UG949: Board and Device Planning Power Estimation and Optimization Design Hub](#)  
[I/O and Clock Planning Design Hub](#)

## DESIGN ENTRY AND IMPLEMENTATION

### Logic Designer

#### Define a Good Design Hierarchy

- Define relevant hierarchies to help global placement and floorplanning
- Insert I/O and clock components near the top level
- Add registers at main hierarchical boundaries
- Generate IP and review target device utilization

#### Build and Validate RTL Submodules

- Ensure design adheres to RTL coding guidelines
- Add sufficient registers around DSP and memories
- Use control signals only when absolutely necessary
- Use synthesis attributes to control final logic mapping
- Create simple timing constraints to review estimated timing and address paths with too many logic levels
- Review synthesis log files, utilization report, and elaborated view to identify sub-optimal mapping
- Run Methodology and RTL checks and review issues
- Implement the submodule in out-of-context (OOC) mode to validate implemented performance with a 5 to 10% tighter clock period
- Review utilization and power against original budget
- Simulate the design to validate functionality

#### Assemble and Validate Top-Level Design

- Synthesize the top-level RTL design and resolve all connectivity issues
- Review top-level utilization and clocking guidelines
- Create and validate top-level constraints
- Iterate the RTL and constraints to fix Methodology and DRC issues and meet timing
- Proceed to implementation

#### See Also:

[UG949: Design Creation with RTL and Design Implementation Designing with IP Design Hub](#)  
[Using IP Integrator Design Hub](#)  
[Logic Synthesis Design Hub](#)  
[Applying Design Constraints Design Hub](#)  
[Implementation Design Hub](#)

## TOP-LEVEL CONSTRAINTS VALIDATION

### Baseline the Design

- Validate timing closure feasibility early in the design process after most blocks and key IP are available
- Specify essential constraints only:
  - Use all IP constraints
  - Define realistic primary and generated clocks
  - Define all clock domain crossing constraints
  - Add multicycle paths where required
  - Do not use I/O constraints at this stage
- Ensure path requirements are reasonable
- Validate WNS  $\approx$  0.0 ns using `report_timing_summary` at each stage of the flow:
  - After synthesis
  - Before placement
  - Before and after routing
- Address timing violations early in the flow
- Fix QoR issues in RTL and synthesis for the biggest impact
- Validate with `report_qor_assessment`

### Validate Timing Constraints

- Run `report_timing_summary` or `check_timing` to ensure all clocks are defined and all registers, input ports, and output ports are constrained
- Run `report_methodology` and address all TIMING\* and XDC\* issues
- Run `report_clock_interaction` to ensure each clock pair is safely timed with reasonable path requirements
- Run `report_cdc` to verify all asynchronous clock domain crossing paths are properly constrained and use safe synchronization circuitry
- Run `report_exceptions` to identify timing exceptions that overlap, are ignored, or are inefficient
- Ensure all Critical Warnings are resolved when the design is loaded and constraints are applied

#### See Also:

[UG949: Design Closure](#)

- [Checking That Your Design is Properly Constrained](#)
- [Baselining The Design](#)

[Applying Design Constraints Design Hub](#)

[Timing Closure and Design Analysis Design Hub](#)

## DESIGN ANALYSIS AND CLOSURE

### Identify Timing Violation Root Causes

- Try Intelligent Design Runs or `report_qor_suggestions` for automated analysis and timing closure recommendations
- Use `report_design_analysis` to find the root cause
- For setup paths, check for high datapath delay due to:
  - Large cell delay (7 series > 25%, UltraScale devices > 50%)
  - Large net delay (7 series > 75%, UltraScale devices > 50%)
- For hold paths, check for hold requirement > 0 ns
- Check for high clock skew (> 500 ps), high clock uncertainty (> 200 ps), or both

### Reduce Logic Delay

- Modify RTL to use parallel or efficient operators
- Add pipeline registers and use synthesis retiming
- Add registers on DSP or block RAM outputs
- Use LUT\_REMAP to collapse small LUTs in the longest path
- Pull registers out of the SRL on the SRL input, output, or both
- Remove KEEP/DONT\_TOUCH/MARK\_DEBUG

### Reduce Net Delay

- Review and adjust floorplan constraints
- Optimize high fanout nets
- Address congestion if level > 4 is reported in:
  - `report_design_analysis` placer congestion table
  - Initial estimated router congestion in log file

### Reduce Clock Skew

- Use parallel buffers instead of cascaded buffers
- Use CLOCK\_DELAY\_GROUP between synchronous clocks originating from the same input or PLL
- Add timing exceptions between asynchronous clocks

### Reduce Clock Uncertainty

- Optimize MMCM settings
- Divide clocks with BUFGCE\_DIV in UltraScale devices

#### See Also:

[UG949: Design Closure](#)

- [Understanding Timing Reports](#)
  - [Identifying Timing Violations Root Cause](#)
- [Timing Closure and Design Analysis Design Hub](#)

### Reduce Control Sets

- Avoid MAX\_FANOUT on control signals
- Increase synthesis control set threshold
- Merge equivalent control signals with `opt_design`

### Optimize High Fanout Nets

- Use hierarchy-based register replication in RTL
- Use `opt_design -merge_equivalent_drivers -hier_fanout_limit` for replication efficiency
- Promote to global clocking if not critical
- Force replication with the FORCE\_MAX\_FANOUT property

### Address Congestion

- Lower device utilization and balance SLR utilization
- Try placer directives AltSpreadLogic\* or SSI\_Spread\*
- Identify congested modules with `report_design_analysis -complexity -congestion`
- For congested modules, use the AlternateRoutability block-level synthesis strategy, reduce MUXF\*/CARRY\* with `opt_design`, or use the CELL\_BLOAT\_FACTOR property
- Use global clocking for high fanout nets in congested regions
- Reuse DSP and block RAM placement from previous implementations with low congestion

### Tune the Compilation Flow

- Try several `place_design` directives or use ML-based strategies from `report_qor_suggestions`
- Use block-level synthesis strategies for an optimal netlist
- Overconstrain critical clocks during placement and physical optimization with `set_clock_uncertainty`
- Use incremental compile after minor design modifications

### Analyze and Optimize Power

- Constrain activity, environment, and process
- Try `power_opt` to reduce power consumption
- Maximize use of block RAM cascading

#### See Also:

[UG949: Design Implementation and Design Closure](#)

- [Analyzing and Resolving Timing Violations](#)
  - [Applying Common Timing Closure Techniques](#)
- [Implementation Design Hub](#)  
[Timing Closure and Design Analysis Design Hub](#)